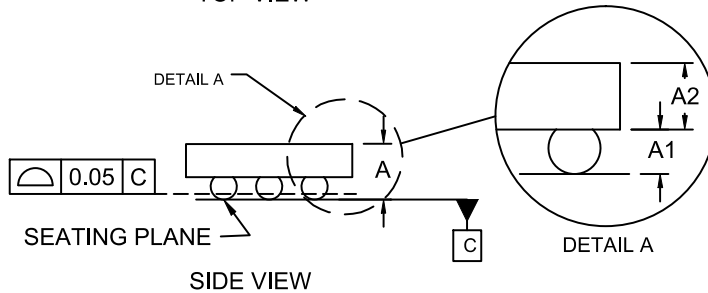
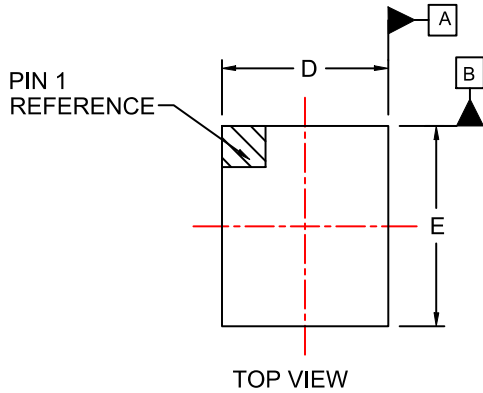


WLCSP12, 1.21x1.67x0.586
CASE 567VZ
ISSUE O

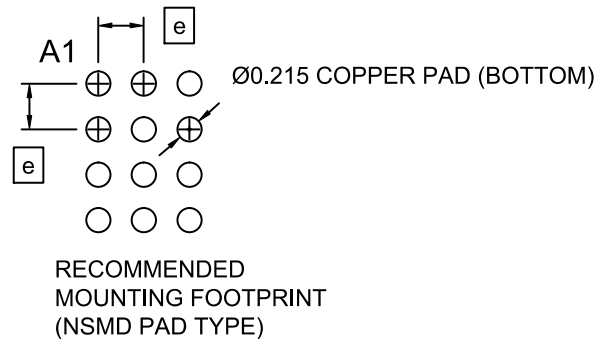
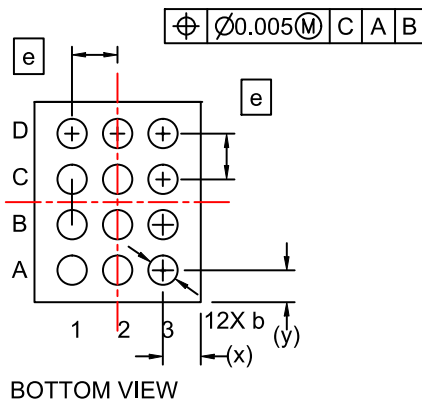
DATE 09 FEB 2018



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DATUM C APPLIES TO THE SPHERICAL CROWN OF THE SOLDER BALLS

| DIM | MILLIMETERS | | |
|-----|-------------|-------|-------|
| | MIN. | NOM. | MAX. |
| A | .536 | .574 | .612 |
| A1 | .176 | .196 | .216 |
| A2 | .360 | .378 | .396 |
| b | .240 | .260 | .280 |
| D | 1.18 | 1.21 | 1.24 |
| E | 1.64 | 1.67 | 1.70 |
| e | 0.40 BSC | | |
| x | 0.190 | 0.205 | 0.220 |
| y | 0.220 | 0.235 | 0.250 |



| | | |
|-------------------------|---------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
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| DESCRIPTION: | WLCSP12, 1.21X1.67X0.586 | PAGE 1 OF 1 |

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